

## RoHS Compliant

### **Features**

- · Wide Viewing Angle 120°C
- · Suitable for all SMT assembly and solder process.
- · High Luminous Intensity and Low Power Dissipation.
- · Good Reliability and Long Life
- · Lead Free

### **Applications**

Optical indicatorRetrofits(replacement)

· Backlighting in dashboard and switch

· Tubular light application

· General use

## **Specifications**

Dice material : AlGaInP
Emmiting Colour : Red
Lens colour : Clear

## Electrical and Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур	Max	Units	Test conditions
Forward voltage	VF	1.8	-	2.4	V	IF=20mA
Reverse Current	IR	-	-	10	uA	VR=5V
Dominant wavelength	λd	617	-	626	nm	IF=20mA

## Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	48	mW
DC Forward Current	IF	20	mA
Peak Forward Current [1]	IFP	75	mA
Reverse Voltage	VR	5	V
Electrostatic Discharge (HBM)	ESD	2000	V
Operating Temperature	Topr	-40 to +85	°C
Storage Temperature	Tstg	-40 to +100	°C

#### Notes:

- 1. 1/10 Duty cycle,0.1ms pulse width.
- 2. Measurement Errors:Forward Voltage:±0.1V
- 3. The tolerance of wave length ±1nm

#### **Selection Guide**

Part Number	Chip materials	Lens Type	Luminous	Viewing Angle		
			Min	Тур	Max	2θ1/2
MP008293	Red (AlGalnP)	Clear	70	-	220	120

#### Note:

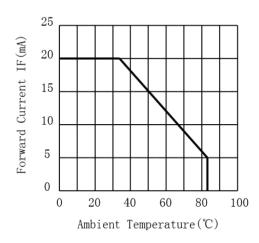
- 1. 201/2 is the angle from optical centerline where the luminous intensity is 201/2 the optical centerline value.
- 2. The above luminous intensity measurement allowance tolerance  $\pm 10\%$

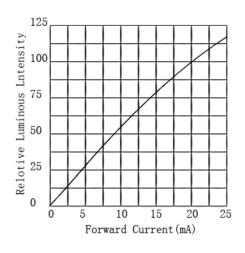
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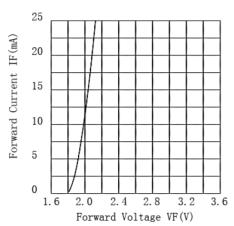


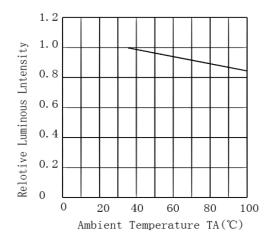
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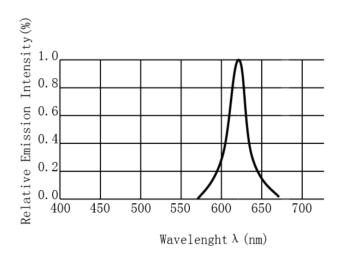
## Typical optical characteristics curves

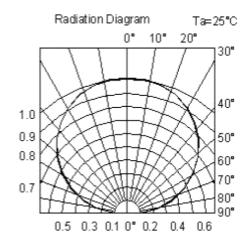










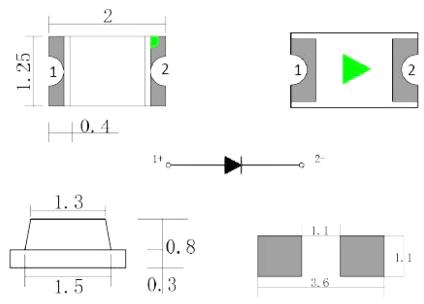


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#### **Dimensions**



Notes Dimensions : Millimetres

- 1. All dimension tolerance is ±0.2mm unless otherwise noted.
- 3. All PCB and markings are subject to change without prior notice.
- 3. Polarity mark ▼or T

### **SMT Reflow Soldering Instructions**

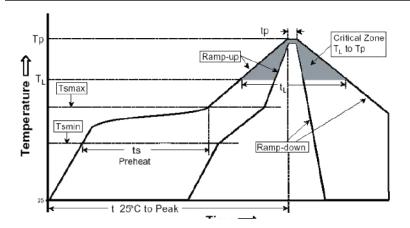
- 1. High temperature welding recommended no more than 2 times
- 2. When soldering, do not put stress on the LEDs during heating
- 3. Reflow temperature distribution (Acc.to J-STD-020D)

Profile feature	Sn-Pb Eutec	tic Assembly	Pb-Free Assembly	
Profile leature	Large body	Small body	Large body	Small body
Average ramp-up rate (TL to Tp)	3°C / second max.			
Preheat -Temperature Min (TSmin) -Temperature Max (TSmax) -Time (min to max) (ts)	100°C 150°C 60 to 120 seconds		150°C 200°C 60 to 180 seconds	
Tsmax to TL -Ramp-up Rate			3°C / sec	cond max.
Time maintained above -Temperature (TL) -Time (tL)	183°C 60 to 150 seconds		217°C 60 to 150 seconds	
Peak Temperature (Tp)	225 +0/-5°C	240 +0/-5°C	245 +0/-5°C	260 +0/-5°C
Time within 5°C of actual Peak Temperature (tp)	10 to 30 seconds		10 to 30 seconds	20 to 40 seconds
Ramp-down Rate	6°C / second max.			
Time 25°C to Peak Temperature	6 minutes max.		8 minutes max.	

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### Soldering iron

- 1. When hand soldering, the temperature of the iron must be less than 350°C for 3 seconds
- 2. The hand solder should be done only once

### **Part Number Table**

Description	Part Number
Chip LED, Red, 626nm, 120°, 220mcd, Surface Mount	MP008293

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